Unit: mm



#### TOSHIBA Diode Silicon Epitaxial Planar Type

# 1SS362FV

## Ultra-High-Speed Switching Applications

AEC-Q101 qualified (Note 1)

Small package

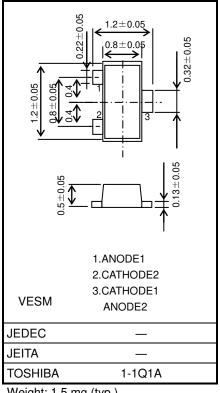
Excellent in forward current and forward voltage characteristics: VF(3) = 0.97 V (typ.)

Fast reverse recovery time:  $t_{rr} = 1.6 \text{ ns (typ.)}$ Small total capacitance: CT = 0.9 pF (typ.)

Note1: For detail information, please contact our sales.

### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse voltage	V <sub>RM</sub>	85	V
Reverse voltage	VR	80	V
Maximum (peak) forward current	IFM	300 *	mA
Average forward current	lo	100 *	mA
Surge current (10 ms)	IFSM	1 *	Α
Power dissipation	Р	150 **	mW
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	-55 to 150	°C



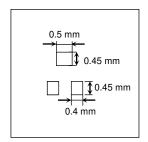
Weight: 1.5 mg (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

\*: Unit rating. Total rating = unit rating × 0.7

\*\*: Mounted on an FR4 board (25.4 mm  $\times$  25.4 mm  $\times$  1.6 mm (t))



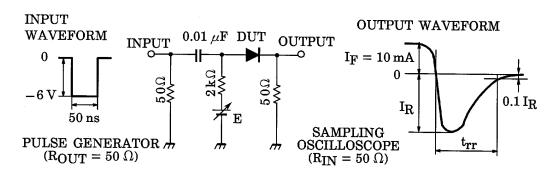
Start of commercial production 2004-09



# **Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	VF (1)	_	IF = 1 mA	_	0.63	_	
	VF (2)	_	IF = 10 mA	_	0.75	_	V
	V <sub>F (3)</sub>	_	IF = 100 mA	_	0.97	1.20	
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 30 V	_	_	0.1	
	IR (2)	_	V <sub>R</sub> = 80 V	_	_	0.5	μΑ
Total capacitance	Ст	_	V <sub>R</sub> = 0 V, f = 1 MHz	_	0.9	_	pF
Reverse recovery time	t <sub>rr</sub>	_	I <sub>F</sub> = 10 mA (Fig. 1)	_	1.6	4.0	ns

Fig. 1 Reverse Recovery Time (trr) Test Circuit

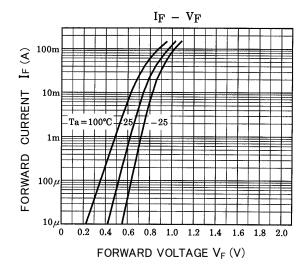


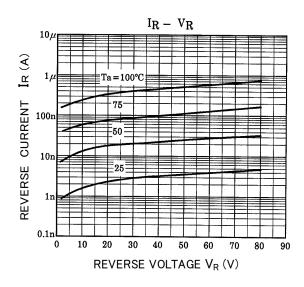
#### Marking

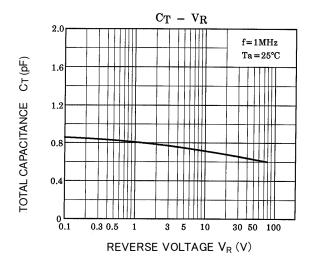
# **Equivalent Circuit (Top View)**

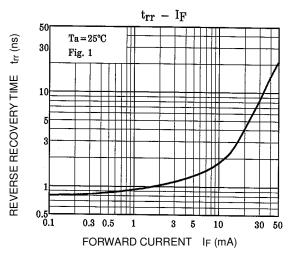














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